R07DS0991EJ0100

Rev.1.00

# μ**PA2631T1**R

P-CHANNEL MOSFET -20 V, -8.0 A, 32 mΩ

Dec 27, 2012

## Description

The  $\mu$ PA2631T1R is P-channel MOS Field Effect Transistors for switching application.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

# Features

- -1.8V drive available
- Low on-state resistance
  - ----  $R_{DS (on)1} = 32 \text{ m}\Omega \text{ MAX}. (V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A})$
  - ----  $R_{DS (on)2} = 41 \text{ m}\Omega \text{ MAX}. (V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A})$
  - ----  $R_{DS (on)3} = 62 \text{ m}\Omega \text{ MAX}. (V_{GS} = -1.8 \text{ V}, I_D = -3.0 \text{ A})$
- Built-in gate protection diode
- Lead-free and Halogen-free



6pinHUSON2020

## **Ordering Information**

Part Number	Package		
μPA2631T1R-E2-AX* <sup>1</sup>	6pinHUSON2020		

Note: \*1.Pb-free (This product does not contain Pb in the external electrode and other parts.)

# Absolute Maximum Ratings ( $T_A = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to Source Voltage ( $V_{GS} = 0 V$ )	V <sub>DSS</sub>	-20	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	∓8	V
Drain Current (DC)	I <sub>D(DC)</sub>	∓6.0	Α
Drain Current (pulse) *1	I <sub>D(pulse)</sub>	∓24	Α
Total Power Dissipation (5 s) *2	PT	2.5	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

Notes: \*1. PW≤10 µs, Duty Cycle≤1%

\*2. Mounted on glass epoxy board of 25.4mm x 25.4mm x 0.8mmt



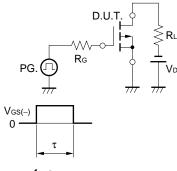
# **Electrical Characteristics (T<sub>A</sub> = 25°C)**

Characteristics	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			-1.0	μA	$V_{DS}$ = -20 V, $V_{GS}$ = 0 V	
Gate Leakage Current	I <sub>GSS</sub>			<b>∓10</b>	μA	V <sub>GS</sub> = ∓8 V, V <sub>DS</sub> = 0 V	
Gate Cut-off Voltage	V <sub>GS(off)</sub>	-0.4		-1.1	V	$V_{DS}$ = -10 V, $I_{D}$ = -1 mA	
Forward Transfer Admittance *1	y <sub>fs</sub>	8.0			S	$V_{DS}$ = -5 V, $I_{D}$ = -3.0 A	
Drain to Source On-state	R <sub>DS(on)1</sub>		23.7	32	mΩ	$V_{GS}$ = -4.5 V, $I_{D}$ = -3.0 A	
Resistance *1	R <sub>DS(on)2</sub>		29.0	41	mΩ	$V_{GS}$ = -2.5 V, I <sub>D</sub> = -3.0 A	
	R <sub>DS(on)3</sub>		37.9	62	mΩ	$V_{GS}$ = -1.8 V, I <sub>D</sub> = -3.0 A	
Input Capacitance	C <sub>iss</sub>		1240		pF	$V_{DS}$ = -10 V, $V_{GS}$ = 0 V,	
Output Capacitance	C <sub>oss</sub>		238		pF	f = 1.0 MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>		184		pF		
Turn-on Delay Time	t <sub>d (on)</sub>		9.5		ns	$I_{\rm D} = -3.0 \text{ A}, V_{\rm DD} = -10.0 \text{ V}, \\ V_{\rm GS} = -4.0 \text{ V}, R_{\rm G} = 6 \Omega$	
Rise Time	tr		5.5		ns		
Turn-off Delay Time	t <sub>d (off)</sub>		89		ns		
Fall Time	t <sub>f</sub>		76		ns		
Total Gate Charge	Q <sub>G</sub>		12.5		nC	$I_D = -6.0 \text{ A}$ , $V_{DD} = -16 \text{ V}$ ,	
Gate to Source Charge	Q <sub>GS</sub>		1.7		nC	V <sub>GS</sub> = -4.5 V	
Gate to Drain Charge	Q <sub>GD</sub>		4.0		nC	1	
Body Diode Forward Voltage *1	V <sub>F(S-D)</sub>			1.5	V	I <sub>F</sub> = 6.0 A, V <sub>GS</sub> = 0 V	

Note: \*1. Pulsed

#### **TEST CIRCUIT 1 SWITCHING TIME**

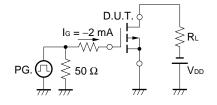
Vdd



 $\tau = 1 \, \mu s$ , Duty Cycle ≤ 1%

#### Vgs(-) VGS Wave Form 0 10% 90% Vgs VDS(-) 90% 90% Vds V<sub>DS</sub> Wave Form 10% 10% 0 tf tr td(on) td(off) tor toff

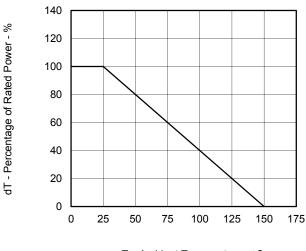
#### **TEST CIRCUIT 2 GATE CHARGE**





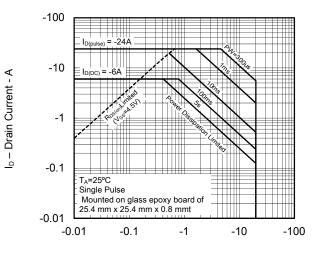
# Typical Characteristics ( $T_A = 25^{\circ}C$ )

DERATING FACTOR OF FORWARD BIAS SAFE **OPERATING AREA** 

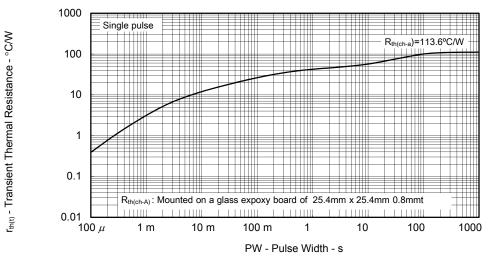


T<sub>A</sub> -Ambient Temperature - °C





V<sub>DS</sub> - Drain to Source Voltage - V





 $\mathsf{P}_{\mathsf{T}}$  - Total Power Dissipation - W 2 1.5 1 0.5 Mounted on a glass expoxy board of 25.4mm x 25.4mm 0.8mmt PW=5sec 0 0 25 50 175 T<sub>A</sub> -Ambient Temperature - °C

3

2.5

TOTAL POWER DISSIPATION vs.

AMBIENT TEMPERATURE

75

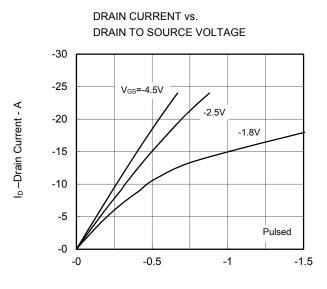
100

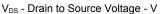
125

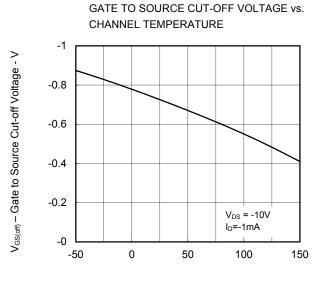
150

175

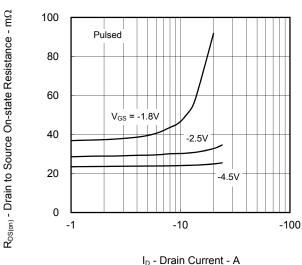






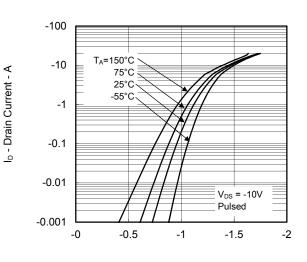


T<sub>ch</sub> - Channel Temperature - °C



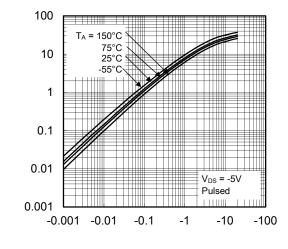
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

FORWARD TRANSFER CHARACTERISTICS

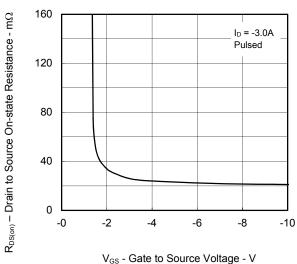


V<sub>GS</sub> - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT





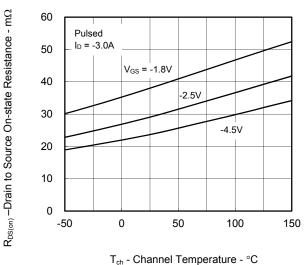


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

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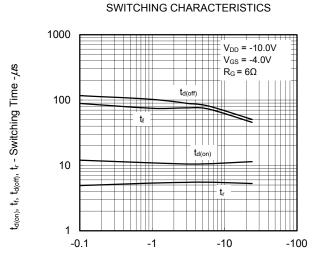


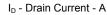
| y<sub>fs</sub> | - Forward Transfer Admittance - S

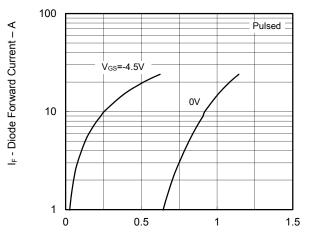


DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE





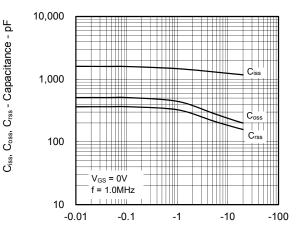




SOURCE TO DRAIN DIODE FORWARD VOLTAGE

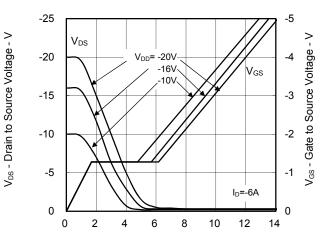
 $V_{F(S\!-\!D)}$  - Drain to Source Voltage - V

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



V<sub>DS</sub> – Drain to Source Voltage - V

DYNAMIC INPUT/OUTPUT CHARACTERISTICS

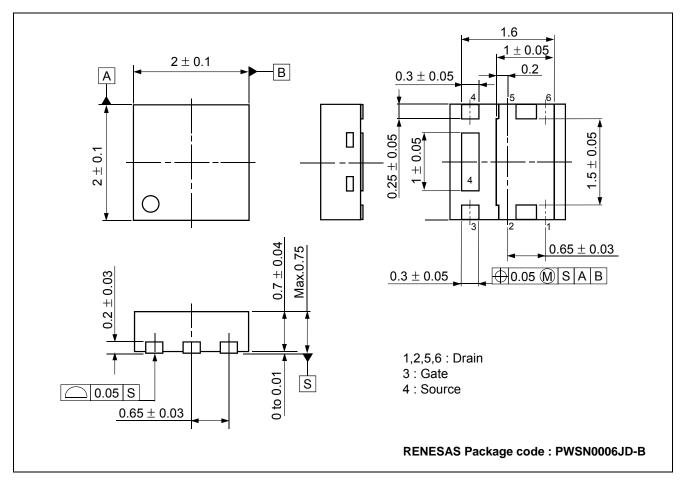


Q<sub>G</sub> - Gate Charge - nC

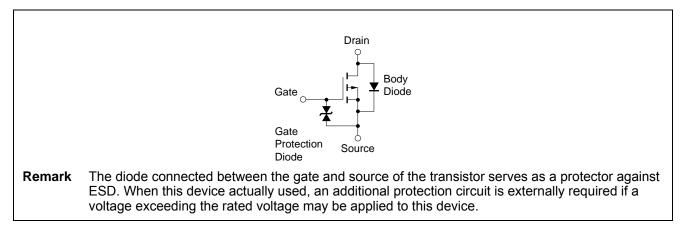


# Package Drawings (Unit: mm)

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### **Equivalent Circuit**





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